# Resonator

# Piezoelectric Resonator (4 to 23.9 MHz)

# FAR Family (C4 series N type)

### **■ DESCRIPTION**

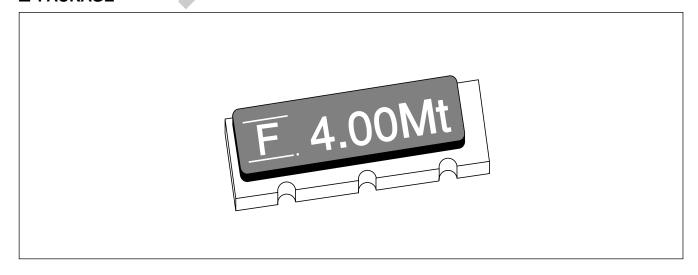
Fujitsu resonators C4 series (N type) feature originally developed single crystals with a high electro-mechanical coefficient (LiNbO<sub>3</sub>: lithium niobate), the result is very compact packaging.

C4 series (N type) with built-in capacitors for exclusive use in microcomputer clocks, and this series is ultra low profile CHIP type device for surface-mount (SMT).

### **■ FEATURES**

- Ultra low profile H = 1.6 mm
- Direct oscillation in 4 to 23.9 MHz frequency.
- Suitable for the source of microcomputer clock
- Emboss-typed pack for automatic mounting
- Superior shock and vibration resistance, preventing damage during automatic mounting

### ■ PACKAGE



## **■ STANDARD CHARACTERISTICS**

Series Parameter	C4 series	s (N type)	Remarks
Material	Lithium Niobate (LiNbO₃)		
Frequency	4 to 17 MHz	17.1 to 23.9 MHz	
Standard frequency	See "■ Standa	ard Frequency."	
Initial frequency deviation	±0.3% (K) ±0.5% (M) ±1.0% (L)	±1.0% (L)	When a frequency of more than 17.1 MHz, only L deviation type can be made.
Temperature characteristic (–20°C to +60°C)	±0.	5%	
Capacity of built-in capacitor	20±8 pF (	(standard)	10±4 pF, 30±8 pF are also available. Capacity is specified by Fujitsu, considering matching data with applied IC (mainly microcomputer).
Aging stability	Within	±0.1%	
Operating temperature	–30°C t	o +85°C	
Storage temperature	–40°C to	+100°C	
Standard measuring circuit	Resonant frequence	су Су	
	1 MΩ  R  C1 C2	FAR	Less than 4 MHz to 10 MHz IC: 1/6MB84069B×2 10 MHz to 20.0 MHz IC: 1/6MC74HC04×2 20.1 MHz to 23.9 MHz IC: 1/6MC74HCU04×2  • Vcc: 5 V DC • R: Resonator • C1, C2: Loading capacitors (built-in)
	Serial resonant res	sistance	
	75 Ω C	R 1 C <sub>2</sub> 75 Ω	R: Resonator Measuring instrument: Network analyzer

### **■ STANDARD FREQUENCY**

Standard frequency (kHz)	Package size	Resonant resistance
4,000 4,194 4,915	N	300 Ω max. (Symbol: 0)
6,000 6,144 7,373 8,000 8,388 9,830 10,000 11,059 12,000 12,288 14,746 16,000 16,934 19,661 20,000	N	75 Ω max. (Symbol: 2)

**Notes:** • Fujitsu can also develop applicable device in addition to standard devices if it's oscillation frequency is from 4 to 23.9 MHz.

- Resonant resistance of the part other than standard, Fujitsu should specify its resonant resistance according to applied frequency. (See "• Frequency and standard resonant resistance.")
- Frequency and standard resonant resistance

Frequency	Standard resonant resistance
4.00 to 5.99 MHz	300 Ω max. (Symbol: 0)
6.00 to 23.99 MHz	75 Ω max. (Symbol: 2)

**Note:** Resonant resistance of custom designed part should be specified considering matching condition with applicable IC by Fujitsu.

### **■ NOTES ON USE**

- · Handle carefully
- · Solder under the following conditions.
  - 5 seconds max. at 230°C (PCB)
  - Recommended preheating is 150°C for one minute in order not to apply extreme heat to the resonator.
- Avoid extreme fluctuations in temperature.
- There is no specific direction in resonator mounting.
- · Oscillation data should be examined when used in oscillation circuit with micon or other ICs.
- This is for reflow solder, not for flow solder.

### **■ PART NUMBERING SYSTEM**

$\frac{\text{FAR}}{}$ $ \frac{\boxed{C 4}}{(1)}$	<u>C</u> <u>N</u> — <u></u>		_	_	_	<u></u>	
(1)	(2) (3)	(4)	(5)	(6)	(7)	(8)	(9)

### (1) Series

Series	Single crystal	Capacitator
C4	LiNbO <sub>3</sub>	With built-in capacitator

## (2) Package Type

Specification	Туре
С	CHIP

### (3) Package Type

Specification	Size
N	$8.0 \times 3.2 \times 1.6$

## (4) Frequency

(Example) Unit: kHz (Specify in five digits.)

Frequency	Specification
7.373 MHz	07373

See "■ Standard Frequency".

### (5) Initial Frequency Deviation

Specification	Deviation
К	±0.3%
M	±0.5%
L	±1.0%

### (6) Built-in Capacitor

Specification	Capacitance
0	20±8 pF
1	10±4 pF
2	30±8 pF

### (7) Resonant Resistance

Specification	Resonant resistance
0	300 Ω max.
2	75 Ω max.

## (8) User-specific Special Symbols

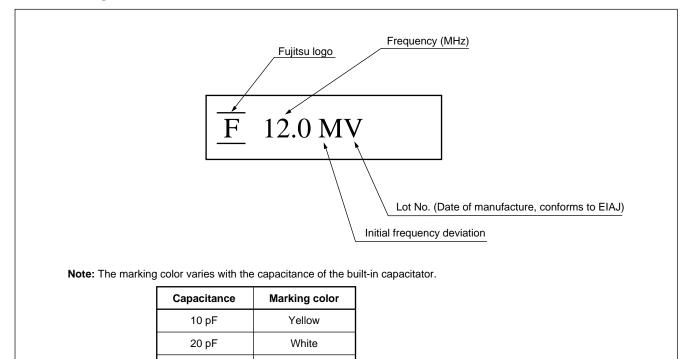
Specification	Description
Name	No specifications, no taping specification
_	No specifications, with taping specification
A to Z	Serial number for custom design

### (9) Resonant Resistance

Specification	Description
R	16 mm wide emboss tape coiled 3,000 times

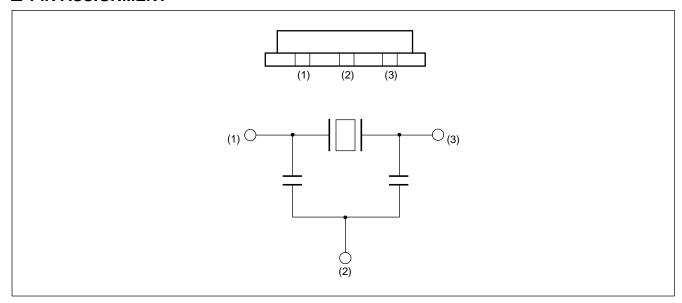
30 pF

### **■ MARKING**

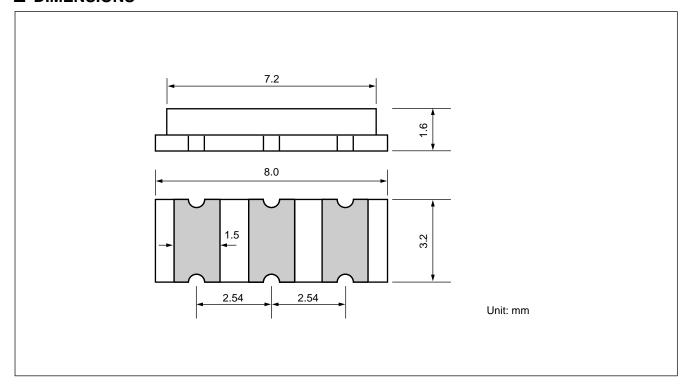


Gray

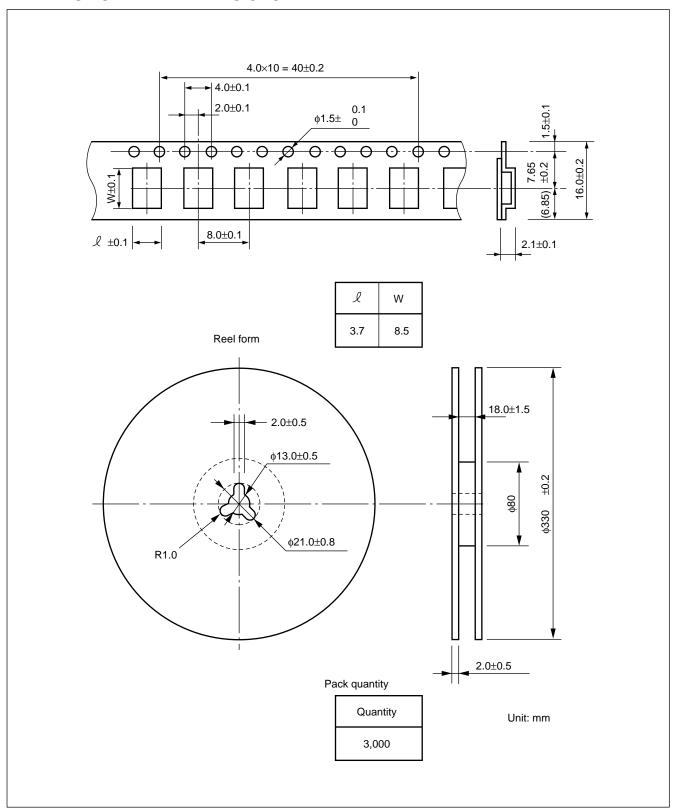
## **■ PIN ASSIGNMENT**



## **■ DIMENSIONS**



## **■ TAPING FORM AND DIMENSIONS**



# **FUJITSU LIMITED**

For further information please contact:

#### Japan

FUJITSU LIMITED Corporate Global Business Support Division Electronic Devices KAWASAKI PLANT, 4-1-1, Kamikodanaka Nakahara-ku, Kawasaki-shi Kanagawa 211-88, Japan

Tel: (044) 754-3763 Fax: (044) 754-3329

#### North and South America

FUJITSU MICROELECTRONICS, INC. Semiconductor Division 3545 North First Street San Jose, CA 95134-1804, U.S.A. Tel: (408) 922-9000

Fax: (408) 432-9044/9045

#### **Europe**

FUJITSU MIKROELEKTRONIK GmbH Am Siebenstein 6-10 63303 Dreieich-Buchschlag Germany

Tel: (06103) 690-0 Fax: (06103) 690-122

#### **Asia Pacific**

FUJITSU MICROELECTRONICS ASIA PTE. LIMITED #05-08, 151 Lorong Chuan New Tech Park

Singapore 556741 Tel: (65) 281-0770 Fax: (65) 281-0220

#### All Rights Reserved.

The contents of this document are subject to change without notice. Customers are advised to consult with FUJITSU sales representatives before ordering.

The information and circuit diagrams in this document presented as examples of semiconductor device applications, and are not intended to be incorporated in devices for actual use. Also, FUJITSU is unable to assume responsibility for infringement of any patent rights or other rights of third parties arising from the use of this information or circuit diagrams.

FUJITSU semiconductor devices are intended for use in standard applications (computers, office automation and other office equipment, industrial, communications, and measurement equipment, personal or household devices, etc.).

CAUTION:

Customers considering the use of our products in special applications where failure or abnormal operation may directly affect human lives or cause physical injury or property damage, or where extremely high levels of reliability are demanded (such as aerospace systems, atomic energy controls, sea floor repeaters, vehicle operating controls, medical devices for life support, etc.) are requested to consult with FUJITSU sales representatives before such use. The company will not be responsible for damages arising from such use without prior approval.

Any semiconductor devices have inherently a certain rate of failure. You must protect against injury, damage or loss from such failures by incorporating safety design measures into your facility and equipment such as redundancy, fire protection, and prevention of over-current levels and other abnormal operating conditions.

If any products described in this document represent goods or technologies subject to certain restrictions on export under the Foreign Exchange and Foreign Trade Control Law of Japan, the prior authorization by Japanese government should be required for export of those products from Japan.

#### F9703

© FUJITSU LIMITED Printed in Japan